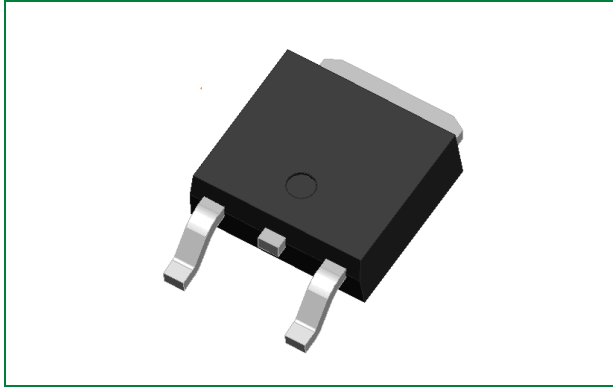


LGD8201TH  
400 V, 20 A N-Channel Ignition IGBT



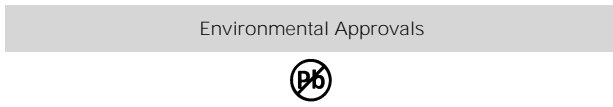
Product Summary

| Characteristic | Value | Unit |
|----------------|-------|------|
| $V_{CES}$      | 400   | V    |
| $I_c$          | 20    | A    |

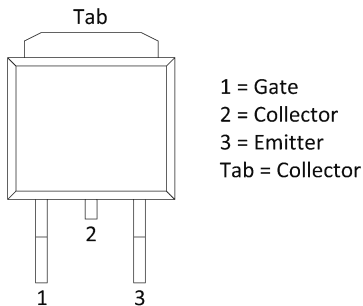
Description

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over-Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

Agency Approvals



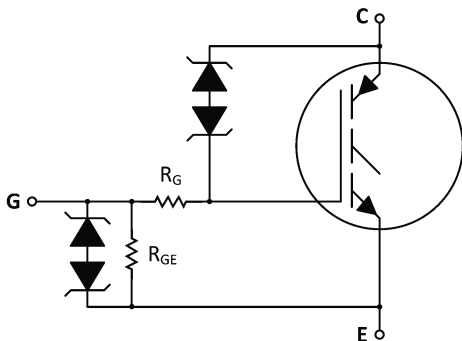
Pinout Diagram



Features

- Ideal for Coil-on-Plug and Driver-on-Coil Applications
- DPAK Package Offers Smaller Footprint for Increased Board Space
- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage Interfaces Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- AEC-Q101 Qualified
- These are Pb-Free Devices

Functional Diagram



- 1. Maximum Ratings ( $T_J = 25\text{ }^\circ\text{C}$  unless otherwise specified) ..... 3
- 2. Unclamped Collector-to-Emitter Avalanche Characteristics ..... 3
- 3. Thermal Characteristics ..... 3
- 4. Electrical Characteristics – Off ..... 4
- 5. Electrical Characteristics – On ..... 4
- 6. Dynamic Characteristics ..... 5
- 7. Switching Characteristics ..... 5
- 8. Figure Data ..... 6
- 9. Package Dimensions ..... 9
- 10. Part Numbering and Marking ..... 9
- 11. Packing Options ..... 9

### 1. Maximum Ratings (T<sub>J</sub> = 25 °C unless otherwise specified)

| Characteristic                          | Conditions             | Symbol                            | Value       | Unit            |
|---|------------------------|-----------------------------------|-------------|-----------------|
| Collector-Emitter Voltage               | -                      | V <sub>CEs</sub>                  | 440         | V               |
| Collector-Gate Voltage                  | -                      | V <sub>CER</sub>                  | 440         | V               |
| Gate-Emitter Voltage                    | -                      | V <sub>GE</sub>                   | ±15         | V               |
| Collector Current – Continuous          | T <sub>C</sub> = 25 °C | I <sub>C</sub>                    | 20          | A <sub>DC</sub> |
| Collector Current – Pulsed              |                        |                                   | 50          | A <sub>AC</sub> |
| Continuous Gate Current                 | -                      | I <sub>G</sub>                    | 1.0         | mA              |
| Transient Gate Current                  | t ≤ 2 ms, f ≤ 100 Hz   |                                   | 20          | mA              |
| ESD – Charged Device Model              | -                      | ESD                               | 2.0         | kV              |
| ESD – Human Body Model                  | R = 1500 Ω, C = 100 pF |                                   | 8.0         | kV              |
| ESD – Machine Model                     | R = 0 Ω, C = 200 pF    |                                   | 500         | V               |
| Total Power Dissipation                 | T <sub>C</sub> = 25 °C | P <sub>D</sub>                    | 125         | W               |
|   | Derating for > 25 °C   |                                   | 0.83        | W/°C            |
| Operating and Storage Temperature Range | -                      | T <sub>J</sub> , T <sub>stg</sub> | -55 to +175 | °C              |

### 2. Unclamped Collector-to-Emitter Avalanche Characteristics

| Characteristic   | Symbol             | Value | Unit |
|--|--------------------|-------|------|
| Single Pulse Collector-to-Emitter Avalanche Energy   |                    |       |      |
| V <sub>CC</sub> = 50 V, V <sub>GE</sub> = 5.0 V, P <sub>kL</sub> = 16.7 A, R <sub>G</sub> = 1000 Ω, L = 1.8 mH, Starting T <sub>J</sub> = 25 °C  | E <sub>AS</sub>    | 250   | mJ   |
| V <sub>CC</sub> = 50 V, V <sub>GE</sub> = 5.0 V, P <sub>kL</sub> = 14.9 A, R <sub>G</sub> = 1000 Ω, L = 1.8 mH, Starting T <sub>J</sub> = 150 °C |                    | 200   |      |
| V <sub>CC</sub> = 50 V, V <sub>GE</sub> = 5.0 V, P <sub>kL</sub> = 14.1 A, R <sub>G</sub> = 1000 Ω, L = 1.8 mH, Starting T <sub>J</sub> = 175 °C |                    | 180   |      |
| Reverse Avalanche Energy   |                    |       |      |
| V <sub>CC</sub> = 100 V, V <sub>GE</sub> = 20 V, P <sub>kL</sub> = 25.8 A, L = 6.0 mH, Starting T <sub>J</sub> = 25 °C                           | E <sub>AS(R)</sub> | 2000  | mJ   |

### 3. Thermal Characteristics

| Characteristic  | Symbol           | Value | Unit |
|---|------------------|-------|------|
| Thermal Resistance, Junction to Case  | R <sub>θJC</sub> | 1.2   | °C/W |
| Thermal Resistance, Junction to Ambient (DPAK) <sup>1</sup>                   | R <sub>θJA</sub> | 95    | °C/W |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds | T <sub>L</sub>   | 275   | °C   |

Footnote 1: When surface mounted to an FR4 board using the minimum recommended pad size

4. Electrical Characteristics – Off

| Characteristic                            | Symbol               | Conditions                                     | Temperature                       | Value |      |                  | Unit |
|---|----------------------|--|-----------------------------------|-------|------|------------------|------|
|   |                      |  |                                   | Min   | Typ  | Max              |      |
| Collector-Emitter Clamp Voltage           | BV <sub>CES</sub>    | I <sub>C</sub> = 2.0 mA                        | T <sub>J</sub> = -40 °C to 175 °C | 370   | 395  | 420              | V    |
|   |                      | I <sub>C</sub> = 10 mA                         |                                   | 390   | 415  | 440              |      |
| Zero Gate Voltage Collector Current       | I <sub>CES</sub>     | V <sub>CE</sub> = 15 V, V <sub>GE</sub> = 0 V  | T <sub>J</sub> = 25 °C            | -     | 0.1  | 1.0              | µA   |
|   |                      |  | T <sub>J</sub> = 175 °C           | 0.5   | 1.5  | 10               |      |
|   |                      | V <sub>CE</sub> = 200 V, V <sub>GE</sub> = 0 V | T <sub>J</sub> = 175 °C           | 1.0   | 25   | 100 <sup>2</sup> |      |
|   |                      |  | T <sub>J</sub> = -40 °C           | 0.4   | 0.8  | 5.0              |      |
| Reverse Collector-Emitter Leakage Current | I <sub>CES(R)</sub>  | V <sub>CE</sub> = -24 V                        | T <sub>J</sub> = 25 °C            | 0.05  | 0.1  | 1.0              | mA   |
|   |                      |  | T <sub>J</sub> = 175 °C           | 1.0   | 5    | 10               |      |
|   |                      |  | T <sub>J</sub> = -40 °C           | 0.005 | 0.01 | 0.1              |      |
| Reverse Collector-Emitter Clamp Voltage   | BV <sub>CES(R)</sub> | I <sub>C</sub> = -75 mA                        | T <sub>J</sub> = 25 °C            | 30    | 35   | 39               | V    |
|   |                      |  | T <sub>J</sub> = 175 °C           | 35    | 39   | 45 <sup>2</sup>  |      |
|   |                      |  | T <sub>J</sub> = -40 °C           | 30    | 33   | 37               |      |
| Gate-Emitter Clamp Voltage                | BV <sub>GES</sub>    | I <sub>G</sub> = ±5.0 mA                       | T <sub>J</sub> = -40 °C to 175 °C | 12    | 12.5 | 14               | V    |
| Gate-Emitter Leakage Current              | I <sub>GES</sub>     | V <sub>GE</sub> = ±5.0 V                       | T <sub>J</sub> = -40 °C to 175 °C | 200   | 300  | 350 <sup>2</sup> | µA   |
| Gate Resistor                             | R <sub>G</sub>       | -  | T <sub>J</sub> = -40 °C to 175 °C | -     | 70   | -                | Ω    |
| Gate-Emitter Resistor                     | R <sub>GE</sub>      | -  | T <sub>J</sub> = -40 °C to 175 °C | 14.25 | 16   | 25               | kΩ   |

Footnote 2: Maximum value of characteristic across temperature range

5. Electrical Characteristics – On

| Characteristic                                 | Symbol                  | Conditions  | Temperature             | Value |      |                  | Unit  |
|--|-------------------------|---|-------------------------|-------|------|------------------|-------|
|  |                         |   |                         | Min   | Typ  | Max              |       |
| Gate Threshold Voltage                         | V <sub>GE(th)</sub>     | I <sub>C</sub> = 1.0 mA,<br>V <sub>GE</sub> = V <sub>CE</sub> | T <sub>J</sub> = 25 °C  | 1.5   | 1.8  | 2.1              | V     |
|  |                         |   | T <sub>J</sub> = 175 °C | 0.7   | 1.0  | 1.3              |       |
|  |                         |   | T <sub>J</sub> = -40 °C | 1.7   | 2.0  | 2.3 <sup>2</sup> |       |
| Threshold Temperature Coefficient (Negative)   | -                       | -   | -                       | 4.0   | 4.6  | 5.2              | mV/°C |
| Collector-Emitter On-Voltage <sup>3</sup>      | V <sub>CE(on)</sub>     | I <sub>C</sub> = 6.5 A, V <sub>GE</sub> = 3.7 V               | T <sub>J</sub> = 25 °C  | 0.95  | 1.15 | 1.35             | V     |
|  |                         |   | T <sub>J</sub> = 175 °C | 0.7   | 0.95 | 1.15             |       |
|  |                         |   | T <sub>J</sub> = -40 °C | 1.0   | 1.3  | 1.4              |       |
|  |                         | I <sub>C</sub> = 9.0 A, V <sub>GE</sub> = 3.9 V               | T <sub>J</sub> = 25 °C  | 0.95  | 1.25 | 1.45             |       |
|  |                         |   | T <sub>J</sub> = 175 °C | 0.8   | 1.05 | 1.25             |       |
|  |                         |   | T <sub>J</sub> = -40 °C | 1.1   | 1.4  | 1.5              |       |
|  |                         | I <sub>C</sub> = 7.5 A, V <sub>GE</sub> = 4.5 V               | T <sub>J</sub> = 25 °C  | 0.85  | 1.15 | 1.4              |       |
|  |                         |   | T <sub>J</sub> = 175 °C | 0.7   | 0.95 | 1.2              |       |
|  |                         |   | T <sub>J</sub> = -40 °C | 1.0   | 1.3  | 1.6 <sup>2</sup> |       |
|  |                         | I <sub>C</sub> = 10 A, V <sub>GE</sub> = 4.5 V                | T <sub>J</sub> = 25 °C  | 1.0   | 1.3  | 1.6              |       |
|  |                         |   | T <sub>J</sub> = 175 °C | 0.8   | 1.05 | 1.4              |       |
|  |                         |   | T <sub>J</sub> = -40 °C | 1.1   | 1.4  | 1.7 <sup>2</sup> |       |
|  |                         | I <sub>C</sub> = 15 A, V <sub>GE</sub> = 4.5 V                | T <sub>J</sub> = 25 °C  | 1.15  | 1.45 | 1.7              |       |
|  |                         |   | T <sub>J</sub> = 175 °C | 1.0   | 1.3  | 1.55             |       |
|  |                         |   | T <sub>J</sub> = -40 °C | 1.25  | 1.55 | 1.8 <sup>2</sup> |       |
| I <sub>C</sub> = 20 A, V <sub>GE</sub> = 4.5 V | T <sub>J</sub> = 25 °C  | 1.3   | 1.6                     | 1.9   |      |                  |       |
|  | T <sub>J</sub> = 175 °C | 1.2   | 1.5                     | 1.8   |      |                  |       |
|  | T <sub>J</sub> = -40 °C | 1.4   | 1.75                    | 2.0   |      |                  |       |
| Forward Transconductance                       | gfs                     | V <sub>CS</sub> = 5.0 V, I <sub>C</sub> = 6.0 A               | T <sub>J</sub> = 25 °C  | 10    | 18   | 25               | Mhos  |

Footnote 2: Maximum value of characteristic across temperature range

Footnote 3: Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%

## 6. Dynamic Characteristics

| Characteristic       | Symbol    | Conditions  | Temperature                       | Value |      |      | Unit |
|----------------------|-----------|---|-----------------------------------|-------|------|------|------|
|                      |           |   |                                   | Min   | Typ  | Max  |      |
| Input Capacitance    | $C_{ISS}$ | $V_{CC} = 25 \text{ V}$ ,<br>$f = 10 \text{ kHz}$ | $T_J = 25 \text{ }^\circ\text{C}$ | 1100  | 1300 | 1500 | pF   |
| Output Capacitance   | $C_{OSS}$ |   |                                   | 70    | 80   | 90   |      |
| Transfer Capacitance | $C_{RSS}$ |   |                                   | 18    | 20   | 22   |      |

## 7. Switching Characteristics

| Characteristic                  | Symbol                             | Conditions  | Temperature                       | Value |     |     | Unit          |
|---------------------------------|------------------------------------|---|-----------------------------------|-------|-----|-----|---------------|
|                                 |                                    |   |                                   | Min   | Typ | Max |               |
| Turn-off Delay Time (Resistive) | $t_{d(off)}$                       | $V_{CC} = 300 \text{ V}$ , $I_C = 9.0 \text{ A}$ ,<br>$R_G = 1.0 \text{ k}\Omega$ , $R_L = 33 \text{ }\Omega$ ,<br>$V_{GE} = 5.0 \text{ V}$     | $T_J = 25 \text{ }^\circ\text{C}$ | 6.0   | 8.0 | 10  | $\mu\text{s}$ |
|                                 | $T_J = 175 \text{ }^\circ\text{C}$ |   | 6.0                               | 8.0   | 10  |     |               |
| Fall Time (Resistive)           | $t_f$                              |   | $T_J = 25 \text{ }^\circ\text{C}$ | 4.0   | 6.0 | 8.0 | $\mu\text{s}$ |
|                                 | $T_J = 175 \text{ }^\circ\text{C}$ |   | 8.0                               | 10.5  | 14  |     |               |
| Turn-off Delay Time (Inductive) | $t_{d(off)}$                       | $V_{CC} = 300 \text{ V}$ , $I_C = 9.0 \text{ A}$ ,<br>$R_G = 1.0 \text{ k}\Omega$ , $L = 300 \text{ }\mu\text{H}$ ,<br>$V_{GE} = 5.0 \text{ V}$ | $T_J = 25 \text{ }^\circ\text{C}$ | 3.0   | 5.0 | 7.0 | $\mu\text{s}$ |
|                                 | $T_J = 175 \text{ }^\circ\text{C}$ |   | 5.0                               | 7.0   | 9.0 |     |               |
| Fall Time (Inductive)           | $t_f$                              |   | $T_J = 25 \text{ }^\circ\text{C}$ | 1.5   | 3.0 | 4.5 | $\mu\text{s}$ |
|                                 | $T_J = 175 \text{ }^\circ\text{C}$ |   | 5.0                               | 7.0   | 10  |     |               |
| Turn-on Delay Time              | $t_{d(on)}$                        | $V_{CC} = 14 \text{ V}$ , $I_C = 9.0 \text{ A}$ ,<br>$R_G = 1.0 \text{ k}\Omega$ , $R_L = 1.5 \text{ }\Omega$ ,<br>$V_{GE} = 5.0 \text{ V}$     | $T_J = 25 \text{ }^\circ\text{C}$ | 1.0   | 1.5 | 2.0 | $\mu\text{s}$ |
|                                 | $T_J = 175 \text{ }^\circ\text{C}$ |   | 1.0                               | 1.5   | 2.0 |     |               |
| Rise Time                       | $t_r$                              |   | $T_J = 25 \text{ }^\circ\text{C}$ | 4.0   | 6.0 | 8.0 | $\mu\text{s}$ |
|                                 | $T_J = 175 \text{ }^\circ\text{C}$ |   | 3.0                               | 5.0   | 7.0 |     |               |

### 8. Figure Data

Figure 1. Self-Clamped Inductive Switching

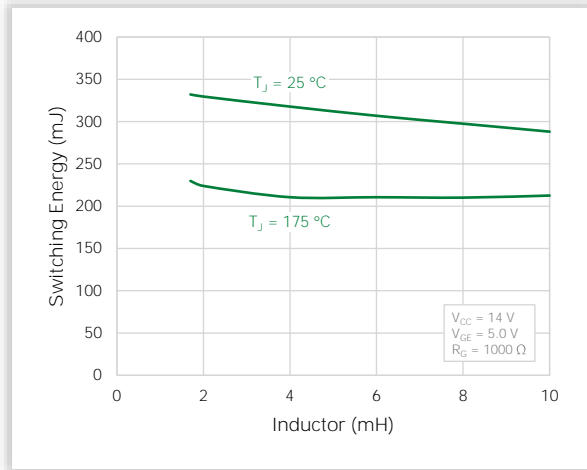


Figure 2. Open Secondary Avalanche Current vs. Temperature

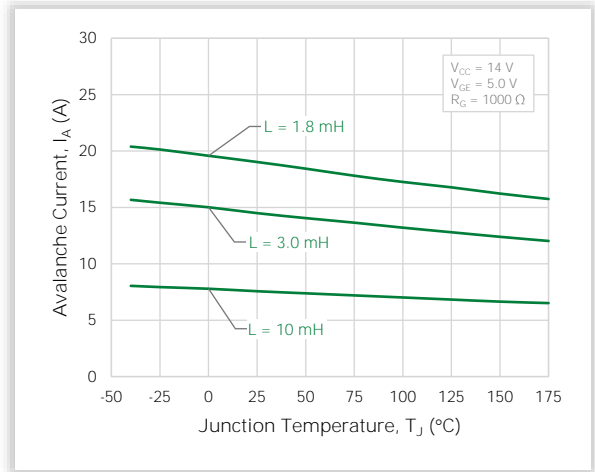


Figure 3. Collector-Emitter Voltage vs. Junction Temperature

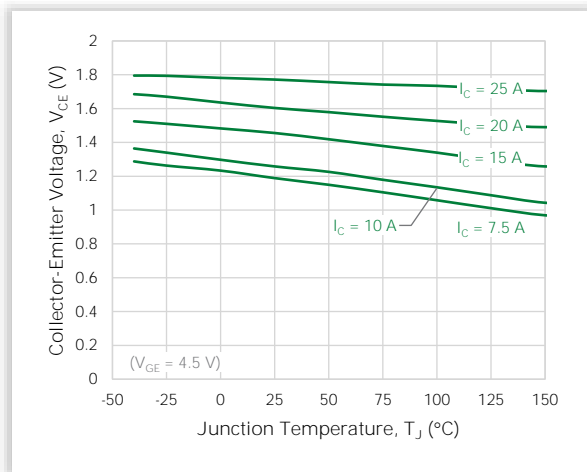


Figure 4. Output Characteristics (Tj = 175 °C)

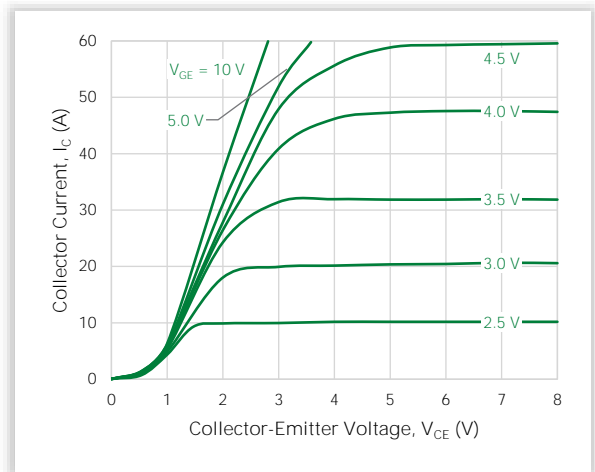


Figure 5. Output Characteristics (Tj = 25 °C)

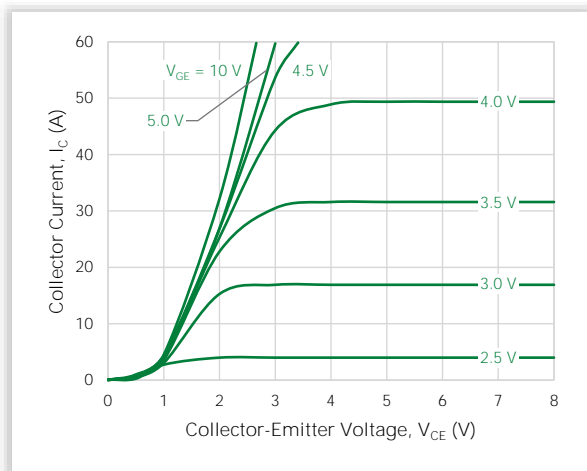


Figure 6. Output Characteristics (Tj = -40 °C)

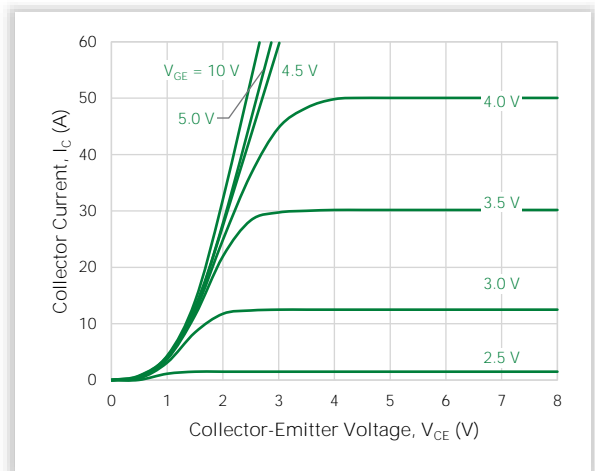


Figure 7. Transfer Characteristics

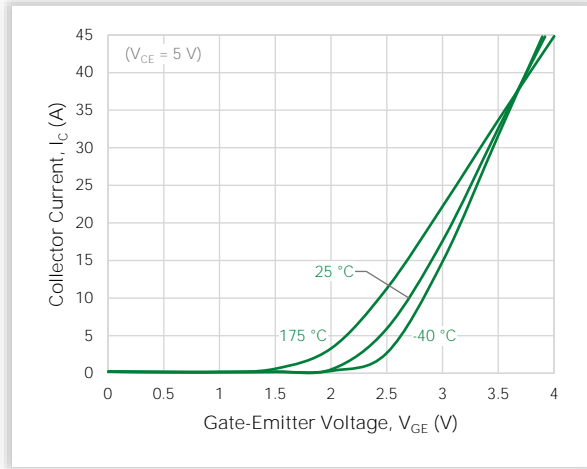


Figure 8. Collector-Emitter Leakage Current vs. Temperature

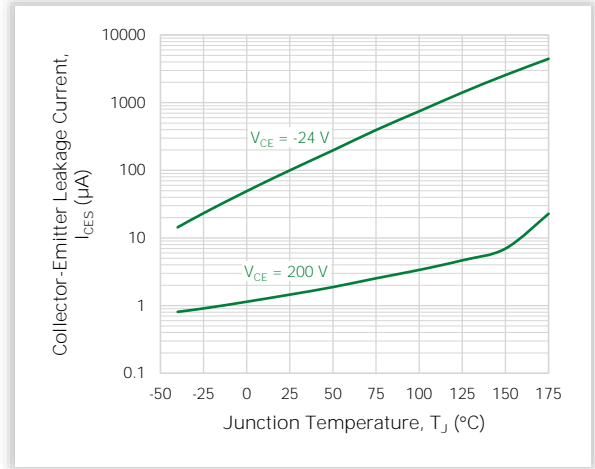


Figure 9. Gate Threshold Voltage vs. Temperature

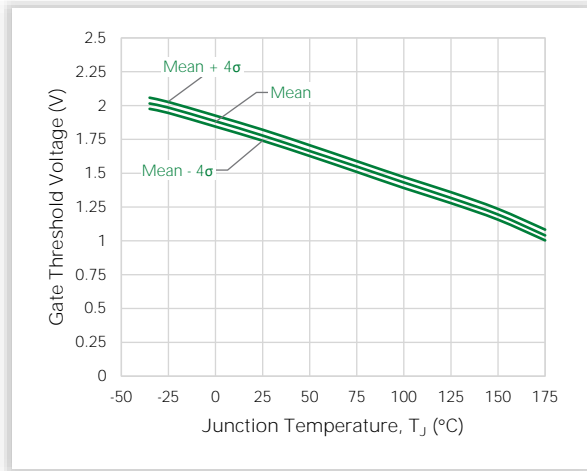


Figure 10. Capacitance Variance

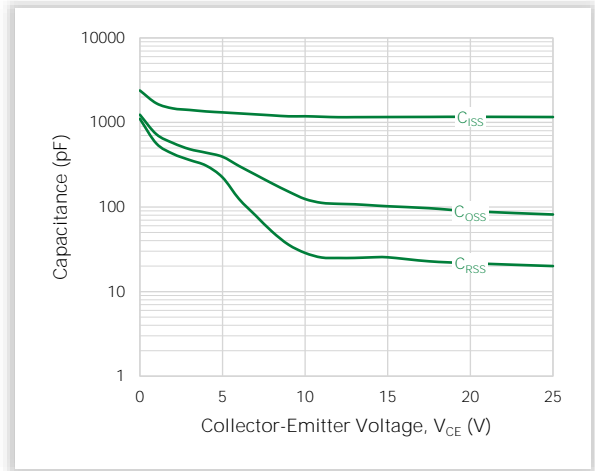


Figure 11. Resistive Switching Fall Time vs. Temperature

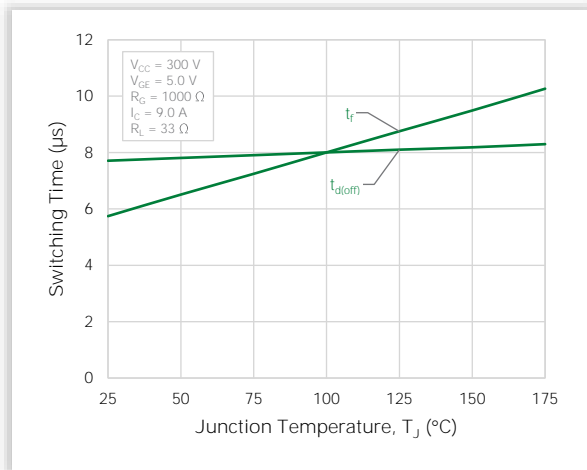


Figure 12. Inductive Switching Fall Time vs. Temperature

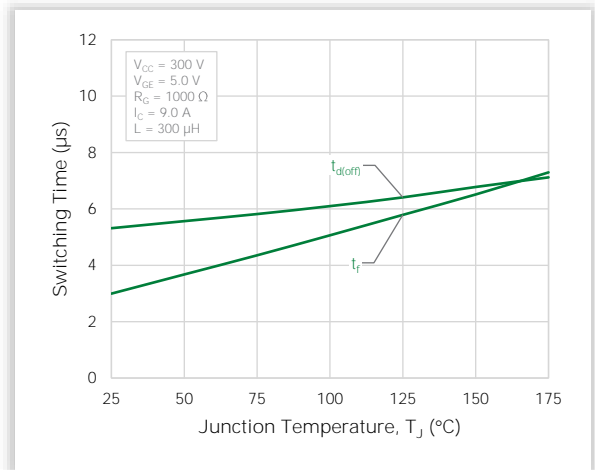


Figure 13. Minimum Pad Transient Thermal Resistance  
(Non-normalized Junction-Ambient)

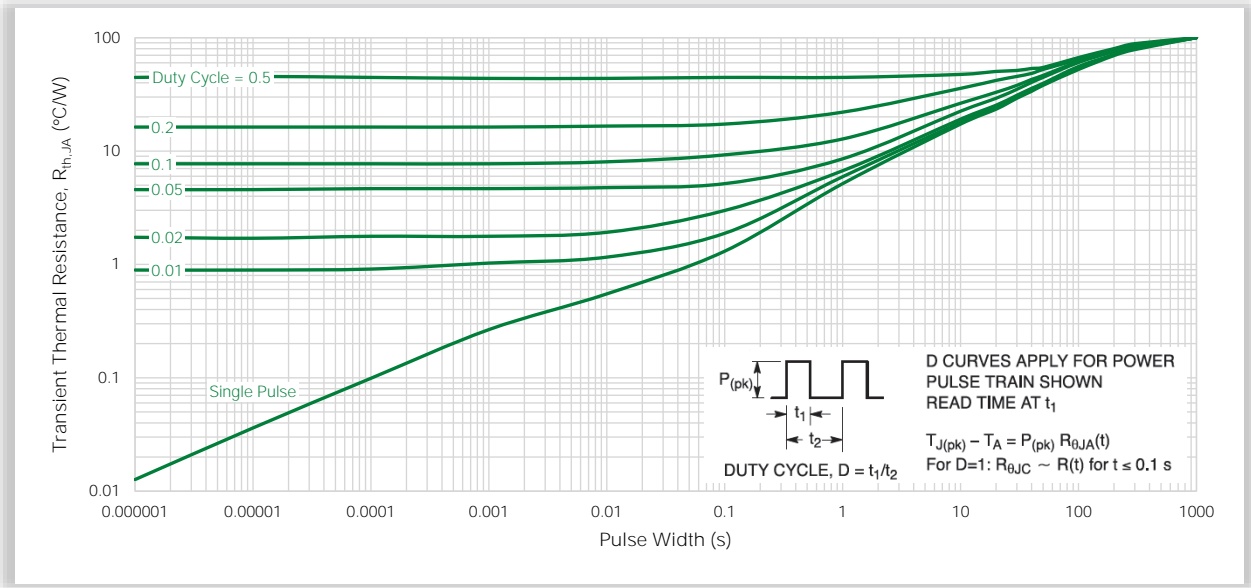
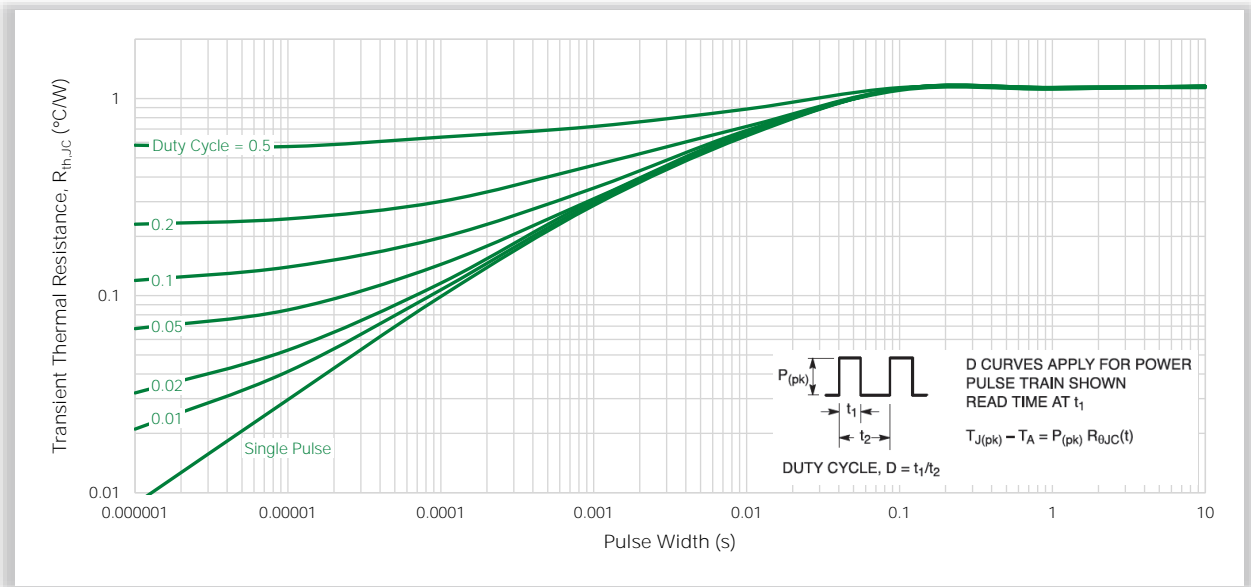
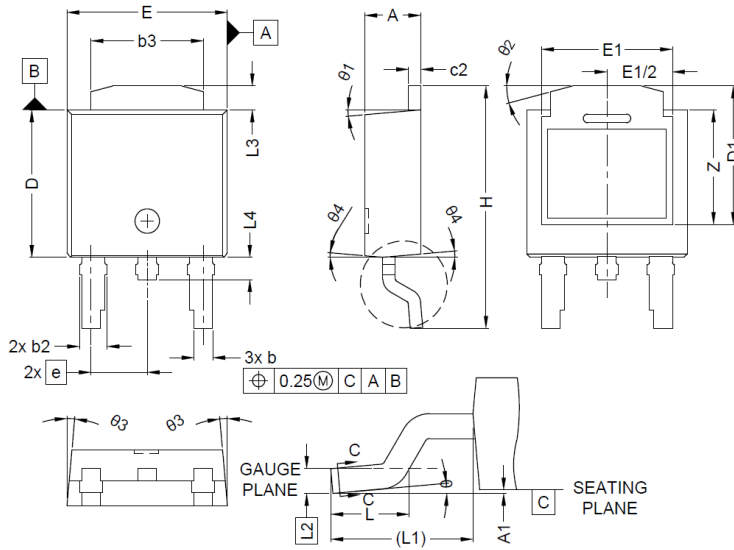


Figure 14. Best Case Transient Thermal Resistance  
(Non-normalized Junction-Case mounted on cold plate)

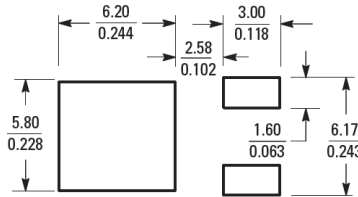




### 9. Package Dimensions



Recommended Solder Pad Layout:

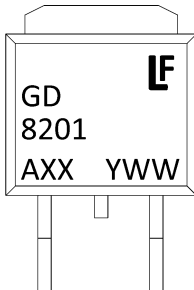


Notes:

1. DIMENSIONING & TOLERANCEING CONFIRM TO ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
3. HEAT SINK SIDE FLASH IS MAX. 0.8mm .
4. RADIUS ON TERMINAL IS OPTIONAL.

| Symbol  | Millimeters |     |       |
|---------|-------------|-----|-------|
|         | Min         | Nom | Max   |
| A       | 2.18        | -   | 2.38  |
| A1      | 0.00        | -   | 0.13  |
| b       | 0.63        | -   | 0.89  |
| b2      | 0.72        | -   | 1.14  |
| b3      | 4.57        | -   | 5.46  |
| c       | 0.46        | -   | 0.61  |
| c2      | 0.46        | -   | 0.61  |
| D       | 5.97        | -   | 6.22  |
| D1      | 5.45        | -   | 5.85  |
| E       | 6.35        | -   | 6.73  |
| E1      | 5.14        | -   | 5.54  |
| e       | 2.29 BSC    |     |       |
| H       | 9.40        | -   | 10.41 |
| L       | 1.40        | -   | 1.78  |
| L1      | 2.90 REF    |     |       |
| L2      | 0.51 BSC    |     |       |
| L3      | 0.89        | -   | 1.27  |
| L4      | -           | -   | 1.01  |
| Z       | 3.93        | -   | -     |
| theta   | 0°          | -   | 10°   |
| theta 1 | 0°          | -   | 10°   |
| theta 2 | 10°         | -   | 20°   |
| theta 3 | 0°          | -   | 10°   |
| theta 4 | 0°          | -   | 10°   |

### 10. Part Numbering and Marking



- GD8201 = Device Code
- A = Assembly Location
- XX = Lot Number
- Y = Year
- WW = Work Week

### 11. Packing Options

| Part Number | Package        | Packing Mode | M.O.Q. |
|-------------|----------------|--------------|--------|
| LGD8201TH   | DPAK (Pb-Free) | Tape & Reel  | 2500   |

For additional information please visit [www.Littelfuse.com/powersemi](http://www.Littelfuse.com/powersemi)

Disclaimer Notice - Littelfuse products are not designed for, and shall not be used for, any purpose (including, without limitation, automotive, military, aerospace, medical, life-saving, life-sustaining or nuclear facility applications, devices intended for surgical implant into the body, or any other application in which the failure or lack of desired operation of the product may result in personal injury, death, or property damage) other than those expressly forth in applicable Littelfuse product documentation. Littelfuse shall not be liable for any claims or damages arising out of products used in applications not expressly intended by Littelfuse as set forth in applicable Littelfuse documentation.

Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics)